

### Bi-Directional Coupler **SYBDC-20-61WHP+**

50Ω 20 dB Coupling 0.2 to 60 MHz 80 Watt

#### THE BIG DEAL

- · High power handling, up to 80W
- Low mainline loss, 0.15 dB typ.
- · High directivity, 20 dB typ.
- Excellent VSWR, 1.12:1 typ.



+RoHS Compliant
The +Suffix identifies RoHS Compliance,
See our website for methodologies and qualifications

#### **APPLICATIONS**

- Military mobile
- · Signal monitoring

#### **PRODUCT OVERVIEW**

Mini-Circuits' SYBDC-20-61WHP+ surface mount bi-directional coupler provides high power handling up to 80W and low mainline loss of 0.15 dB typically for applications from 0.2 to 60 MHz. The coupler features core and wire construction mounted on an 8-lead printed laminate base with wrap-around terminations for excellent solderability. The unit measures 0.433 x 0.690 x 0.400 '', accommodating dense circuit board layouts.

#### **KEY FEATURES**

Feature	Advantages
High power handling, 80W	Usable in many systems with high-power requirements
Low mainline loss, 0.15 dB typ.	Provides excellent through-path signal power transmission
Good directivity, 20 dB typ.	High directivity allows accurate signal sampling through the coupled port with minimal measurement error
Excellent VSWR, 1.12 dB typ. (input/output/coupling)	Provides excellent matching in $50\Omega$ systems with minimal signal reflection
Small size, 0.433 x 0.690 x 0.400 "	Provides high power capability while saving space in systems with tight layouts

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#### **ELECTRICAL SPECIFICATIONS<sup>1</sup> AT 25°C**

Parameter	Condition (MHz)	Min.	Тур.	Max.	Units
Frequency Range		0.2		60	MHz
Mainling Logg (above the gratical 0.044 dD)	1-30	_	0.08	0.25	dB
Mainline Loss (above theoretical 0.044 dB)	0.2-60	_	0.15	0.30	αв
Coupling	0.2-60	19.5	20.5	21.5	dB
Coupling Flatness(±)	0.2-60	_	0.05	0.2	dB
Directivity	1-30	20	25	_	dB
Directivity	0.2-60	15	20	_	αв
Return Loss (Input)	0.2-60	18	25	_	dB
Return Loss (Output)	0.2-60	18	25	_	dB
Return Loss (Coupled)	1-30	18	24	_	dB
Input Power <sup>2</sup>	0.2-60	_	_	80	W

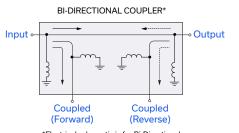
<sup>1.</sup> Measured on Mini-Circuits board TBSYBDC2061WHP+ with test board loss deducted.

#### **MAXIMUM RATINGS\***

Parameter	Ratings		
Operating Temperature	-40°C to 65°C		
Storage Temperature	-55°C to 100°C		

Permanent damage may occur if any of these limits are exceeded.

#### **ELECTRICAL SCHEMATIC**



\*Electrical schematic is for Bi-Directional coupler with internal transformer(s) that routes DC from all ports to ground

<sup>2.</sup> The user must provide adequate means of heat removal to limit the temperature of ground connections 2,3,6,7 to 65°C, in order to ensure proper performance.

At 25°C ambient temperature this requires thermal resistance of the user's PC board heat sink to be 8°C/W or less when the unit is driven at maximum specified RF input power, 80W. At higher ambient temperature, with the same heat sink. Input power in watts must not exceed 80W x (65°C-Tambient)÷40°C.



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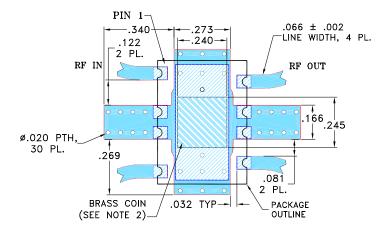
0.2 to 60 MHz 80 Watt 20 dB Coupling 50Ω

#### **PAD CONNECTIONS**

INPUT	1
OUTPUT	8
COUPLED (FORWARD)	4
COUPLED (REVERSE)	5
GROUND	2, 3, 6, 7

#### **PRODUCT MARKING: N/A**

#### **SUGGESTED PCB LAYOUT (PL-351)**



- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

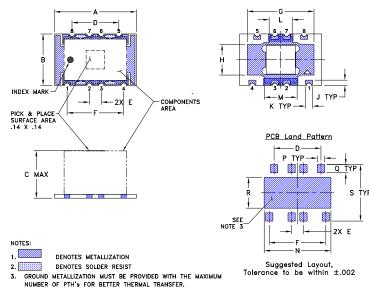
  2. SUGGEST TO PROVIDE BRASS COIN FOR BETTER HEAT TRANSFER FROM THE UNIT. OTHERWISE PROVIDE ARRAY OF THERMAL VIAS ADEQUATE TO LIMIT TEMPERATURE OF GROUND CONNECTIONS UNDER THE UNIT TO 65°C. 3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

DENOTES BRASS COIN.

#### **OUTLINE DRAWING**



#### OUTLINE DIMENSIONS (Inches)

J	Н	G	F	Ε	D	С	В	Α
.045	.257	.560	.476	.100	.394	.400	.433	.690
1.14	6.53	14.22	12.09	2.54	10.01	10.16	11.00	17.53
wt	S	R	Q	Р	N	М	L	К
grams	.475	.258	.069	.061	.561	.276	.194	.060

**TAPE & REEL INFORMATION: F109** 

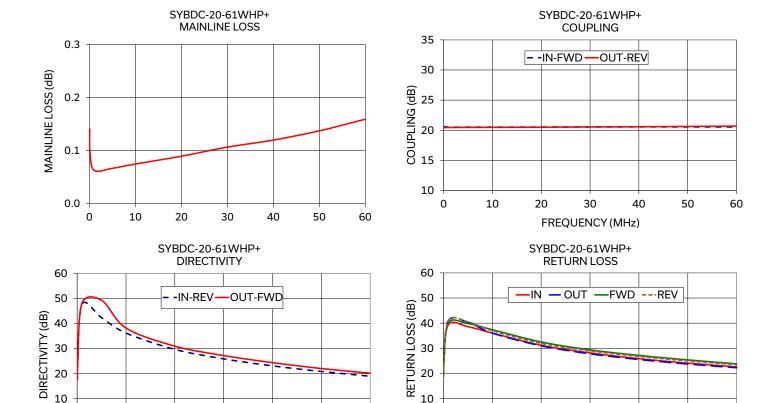


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#### **TYPICAL PERFORMANCE DATA**

Frequency	Mainline Loss (dB)	Coupling (dB)		Directivity (dB)		Return Loss (dB)			
(MHz)	In-Out	In-Cpl Fwd	Out-Cpl Rev	In-Cpl Rev	Out-Cpl Fwd	In	Out	Cpl Fwd	Cpl Rev
0.05	0.14	20.66	20.34	17.89	17.76	18.96	18.96	18.97	18.73
0.10	0.10	20.59	20.44	23.77	23.43	23.87	23.79	23.81	23.54
1	0.06	20.51	20.45	47.62	48.12	39.34	40.90	40.06	40.97
5	0.07	20.52	20.47	42.32	49.28	38.61	40.38	39.84	40.57
10	0.07	20.52	20.47	36.19	38.17	36.07	36.05	37.41	37.02
20	0.09	20.53	20.50	29.68	30.97	31.20	30.98	32.53	31.96
30	0.11	20.54	20.54	25.90	27.21	28.20	27.80	29.39	28.98
40	0.12	20.55	20.58	23.09	24.39	25.89	25.55	27.17	26.77
50	0.14	20.55	20.63	20.87	22.05	24.11	23.73	25.39	24.98
60	0.16	20.54	20.68	18.98	20.19	22.63	22.27	23.83	23.49



#### NOTES

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FREQUENCY (MHz)

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

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B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

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C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

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FREQUENCY (MHz)

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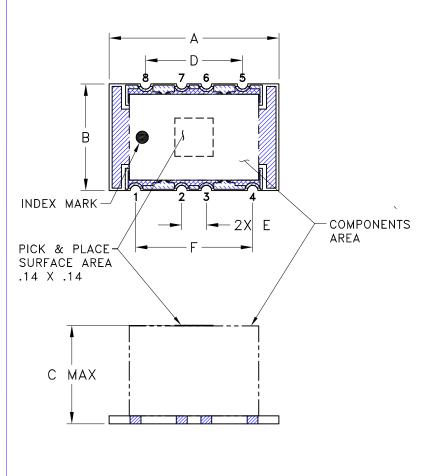
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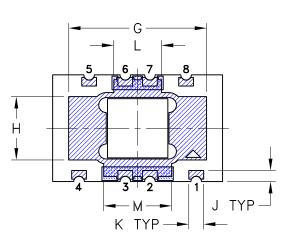
# Case Style

## AH

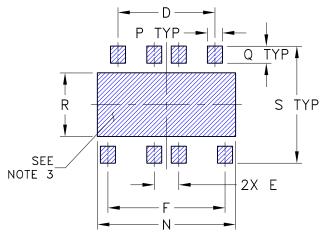
### **Outline Dimensions**

AH1647-5





#### <u>PCB Land Pattern</u>



Suggested Layout,
Tolerance to be within ±.002

#### NOTES:



**DENOTES METALLIZATION** 

2.

**DENOTES SOLDER RESIST** 

3. GROUND METALLIZATION MUST BE PROVIDED WITH THE MAXIMUM NUMBER OF PTH's FOR BETTER THERMAL TRANSFER.

CASE#	A	В	С	D	Е	F	G	Н	J	K	L	M	N
A I I 1 6 4 7 5	.690	.433	.400	.394	.100	.476	.560	.257	.045	.060	.194	.276	.561
AH1647-5	(17.53)	(11.00)	(10.17)	(10.01)	(2.54)	(12.09)	(14.22)	(6.53)	(1.14)	(1.52)	(4.93)	(7.01)	(14.25)

		/	/	/	/ /
CASE#	P	Q	R	S	WT, GRAM
AH1647-5	.061 (1.55)	.069 (1.75)	.258 (6.55)	.475 (12.06)	3.4

Dimensions are in inches (mm). Tolerances: 2 Pl.±.01(.25); 3 Pl.±.005(.127)

#### Notes:

- 1. Base material: Printed wiring laminate;
- 2. Termination finish: TIN HAL LEAD FREE.





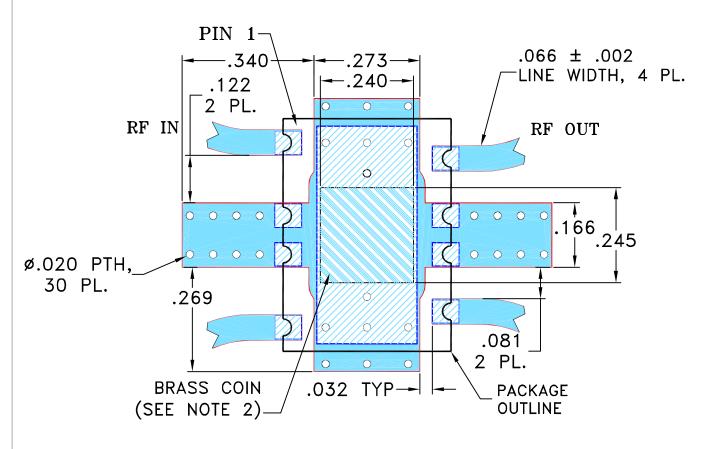
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

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# THIRD ANGLE PROJECTION

		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M133287	NEW RELEASE	08/26/11	GF	WP

#### SUGGESTED MOUNTING CONFIGURATION FOR AH1647 CASE STYLE, "08DC05" PIN CODE



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DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK



DENOTES BRASS COIN.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE			
DIMENSIONS ARE IN INCHES	DRAWN	GF	08/22/11			
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	IL	08/25/11			
3 PL DECIMALS ± .005 ANGLES ±	APPROVED	WP	08/26/11			
FRACTIONS ±						
☐ Mini−Circuits ®						

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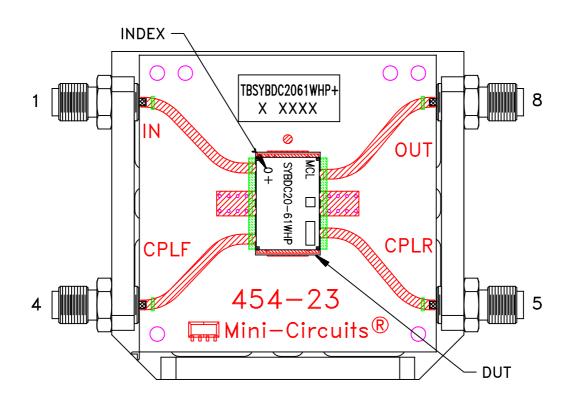
ASHEETA1.DWG	REV:A	DATE:01/12/95

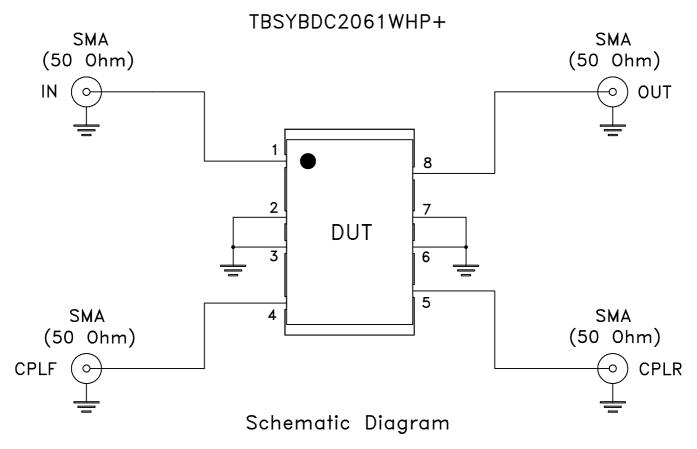
$\prod$	Mini-	-Circ	uits	13 Neptune Avenue Brooklyn NY 11235
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PL, 08DC05, AH1647, TB-630+

SIZE A	code ident 15542	DRAWING	NO: 98-PL	-351		REV: OR	
FILE:	98PL351	SCALE:	4:1	SHEET:	1	OF 1	

### Evaluation Board and Circuit





#### Notes:

- 1. 50 Ohm SMA Female connectors.
- 2. PCB Material: R04350 or equivalent. Dielectric Constant=3.5, Thickness=.030 inch.





#### **Environmental Specifications**

#### ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec	
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet	
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet	
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours	
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C	
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1	
Solderability	10X Magnification	J-STD-002, 95% Coverage	
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D	
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A	
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215	

ENV02T1 Rev: B

02/25/11

M130240 File: ENV02T1.pdf

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